



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts,Customers Priority,Honest Operation,and Considerate Service",our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

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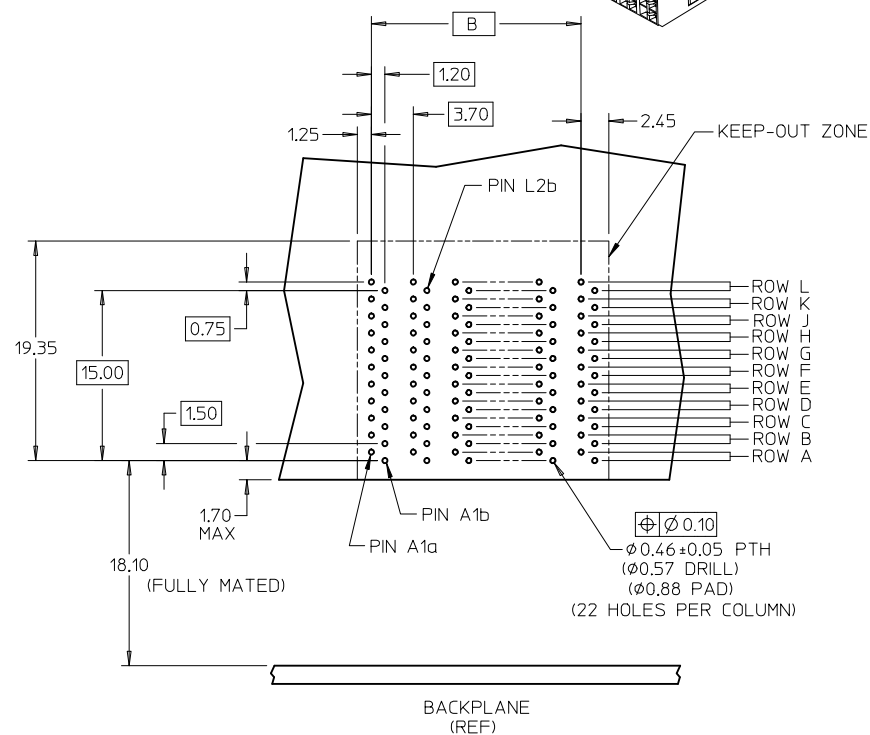
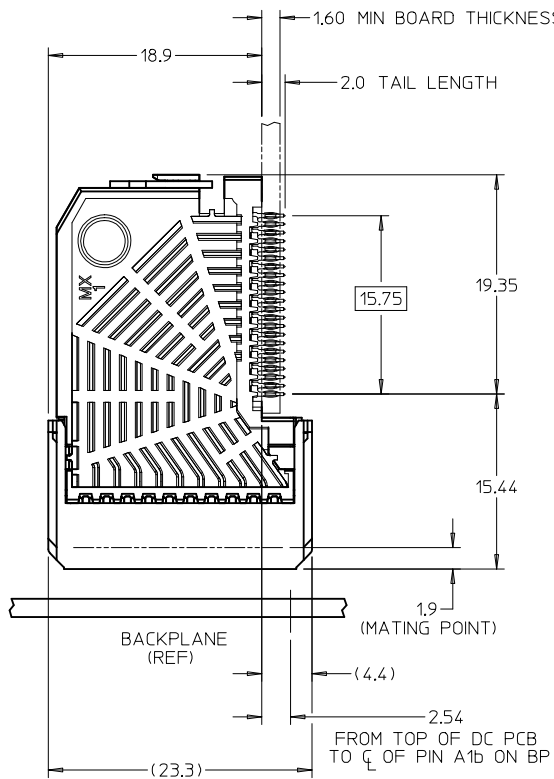
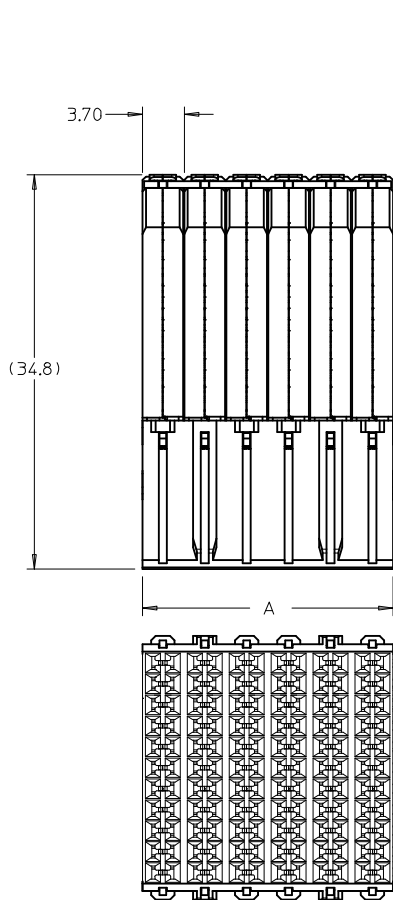
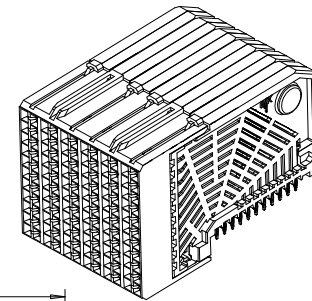


MATERIAL NUMBER	# OF COLUMNS	DIM "A" MAX	DIM "B"
75710-***5	5	18.50	14.80
75710-***6	6	22.20	18.50
75710-***8	8	29.60	25.90
75710-***0	10	37.00	33.30

75710-*0**

MODULE TYPE -- TAIL PLATING TYPE
 UNGUIDED -- MATTE TIN (FORMERLY TIN/LEAD) = 0
 UNGUIDED -- MATTE TIN = 1

OF COLUMNS/PLATING
 05 = 5 COL 30 GOLD
 06 = 6 COL 30 GOLD
 08 = 8 COL 30 GOLD
 10 = 10 COL 30 GOLD
 55 = 5 COL 10 GOLD (MAPS)
 56 = 6 COL 10 GOLD (MAPS)
 58 = 8 COL 10 GOLD (MAPS)
 50 = 10 COL 10 GOLD (MAPS)



DAUGHTERCARD HOLE PATTERN
(CONNECTOR SIDE)

NOTES:

1. MATERIALS: HOUSING - LIQUID CRYSTAL POLYMER (LCP) GLASS-FILLED, UL94V-0
TERMINALS - HIGH PERFORMANCE COPPER ALLOY
2. FINISH: SELECTIVE GOLD IN CONTACT AREA.
SELECTIVE MATTE TIN ON PCB TAILS, NICKEL OVERALL.
3. REFER TO MOLEX PRODUCT SPEC PS-75710-999 FOR PERFORMANCE SPECIFICATIONS.
4. PRODUCT IS PACKAGED PER PK-70873-609.
5. THIS PART CONFORMS TO CLASS B REQUIREMENTS OF COSMETIC SPEC PS-45499-002.
6. MAPS (MOLEX ADVANCED PLATING SYSTEM)

REV	DESCRIPTION	QUALITY SYMBOLS
1	LEAD FREE CON/ MAPS	
2	EC NO: UCP2013-4121	
3	DRW:RWH/PPLE 2013/04/01	
4	CHKD:MMOLFE 2013/04/01	
5	APPR:SMILLER 2013/07/15	

GENERAL TOLERANCES (UNLESS SPECIFIED)	
mm	INCH
4 PLACES ± ---	± ---
3 PLACES ± ---	± ---
2 PLACES ± 0.13	± ---
1 PLACE ± 0.25	± ---
0 PLACE ±	±
ANGULAR ±1/2°	
DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS	

DIMENSION STYLE	
MM ONLY	
DRAWN BY	DATE
JLAURX	09/01/2005
CHECKED BY	DATE
NMARTIN	09/01/2005
APPROVED BY	DATE
CBIXLER	09/01/2005
MATERIAL NO.	
SEE CHART	

SCALE	DESIGN UNITS	THIRD ANGLE PROJECTION
3:1	METRIC	
I-TRAC DAUGHTERCARD 11 ROW SIGNAL MODULE UNGUIDED SALES DWG		
molex		
DOCUMENT NO.	SHEET NO.	
SD-75710-001	1 OF 1	
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